



#### 30V P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

BV <sub>DSS</sub>	RDS(ON) max	I <sub>D</sub> T <sub>A</sub> = +25°C
-30V	75mΩ @ $V_{GS}$ = -10 $V$	-3.9A
-307	98mΩ @ V <sub>GS</sub> = -4.5V	-3.3A

## **Features and Benefits**

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

# **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

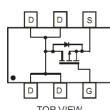
- DC-DC Converters
- **Power Management Functions**
- Backlighting
- Motor Control

### **Mechanical Data**

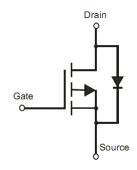
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.013 grams (Approximate)







**TOP VIEW** Internal Schematic



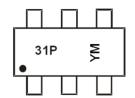
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3105LVT-7	TSOT26	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



31P = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 9 = September)

Date Code Key

Year	2017	2018	20	019	2020	2021		2	2022	2023	202	24	2025
Code	E	F		G	Н	I			J	K	L		M
Month	Jan	Feb	Mar	Apr	May	Jun	Jı	ul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	7	8	9	0	N	D

DMP3105LVT Document number: DS35504 Rev. 3 - 2



# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	-30	V		
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = -10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-3.1 -2.5	А
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-2.7 -2.2	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	-3.9 -3.1	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V	I <sub>D</sub>	-3.3 -2.7	А		
Maximum Continuous Body Diode Forward Current	Is	-2.2	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-20	Α		

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	1.15	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	108	°C/W
Total Power Dissipation (Note 6)	P <sub>D</sub>	1.75	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ hetaJA}$	72	°C/W
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta}$ JC	23.4	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

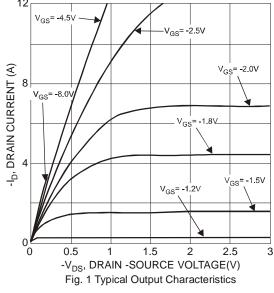
### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

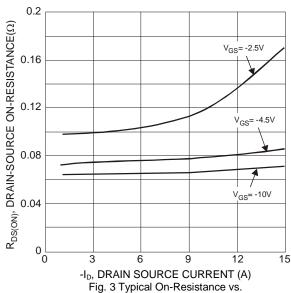
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition			
OFF CHARACTERISTICS (Note 7)									
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$			
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-100	nA	$V_{DS} = -30V, V_{GS} = 0V$			
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$			
ON CHARACTERISTICS (Note 7)									
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.5	-0.9	-1.5	>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$			
			65	75		$V_{GS} = -10V, I_D = -4.2A$			
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		75	98	$m\Omega$	$V_{GS} = -4.5V$ , $I_D = -4.0A$			
		_	98	150		$V_{GS} = -2.5V, I_D = -3.0A$			
Forward Transfer Admittance	Y <sub>fs</sub>	_	5	_	S	$V_{DS} = -15V, I_{D} = -4.0A$			
Diode Forward Voltage	$V_{SD}$	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$			
DYNAMIC CHARACTERISTICS (Note 8)									
Input Capacitance	Ciss		839	_		$V_{DS} = -15V, V_{GS} = 0V$ f = 1.0MHz			
Output Capacitance	Coss		47	_	pF				
Reverse Transfer Capacitance	Crss		43	_		1 = 1.0IVII 12			
Gate Resistance	$R_G$	_	12.3	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$			
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	9.0	_					
Total Gate Charge (V <sub>GS</sub> = -10.0V)	Qg	_	19.8	_	nC	V <sub>DS</sub> = -15V. I <sub>D</sub> = -4.0A			
Gate-Source Charge	Q <sub>gs</sub>	_	1.6	_	iiC	$V_{DS} = -15V, I_{D} = -4.0A$			
Gate-Drain Charge	$Q_{gd}$	_	1.1	_					
Turn-On Delay Time	t <sub>D(ON)</sub>	_	9.7	_					
Turn-On Rise Time	t <sub>R</sub>		17.7	_		$V_{GS} = -10V, V_{DD} = -15V, R_G = 6\Omega,$			
Turn-Off Delay Time	t <sub>D(OFF)</sub>		269		ns	I <sub>D</sub> = -1A			
Turn-Off Fall Time	t <sub>F</sub>	_	64	_					

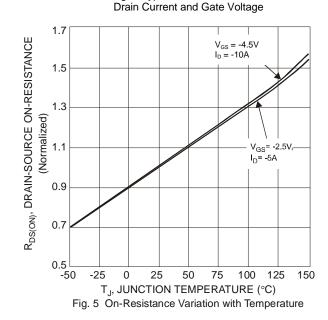
Notes:

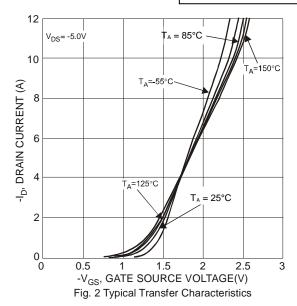
Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.











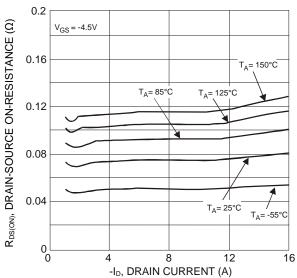


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature

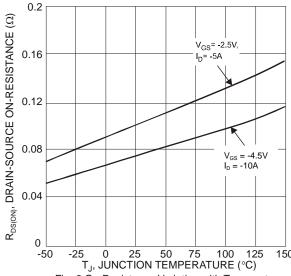
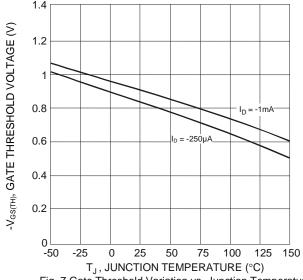
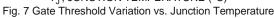


Fig. 6 On-Resistance Variation with Temperature







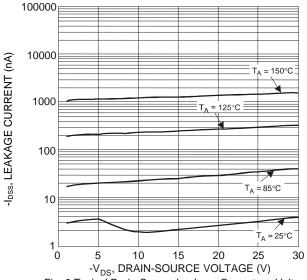


Fig. 9 Typical Drain-Source Leakage Current vs. Voltage

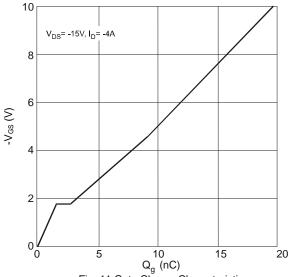
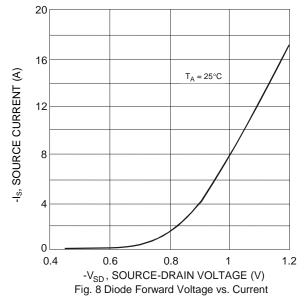
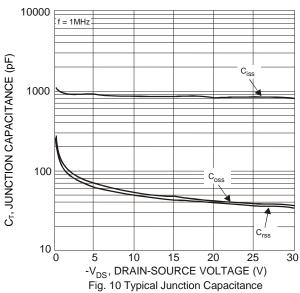
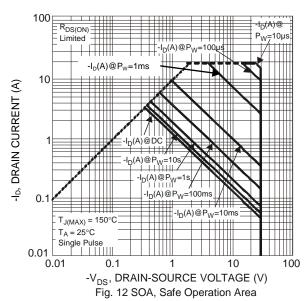


Fig. 11 Gate Charge Characteristics







May 2018



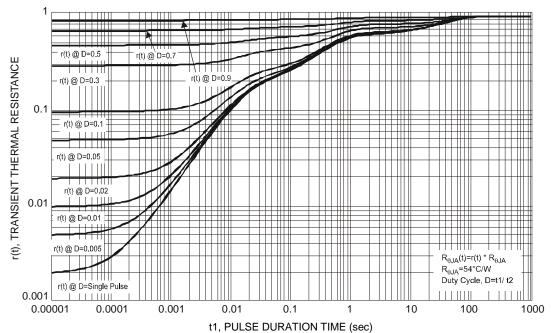


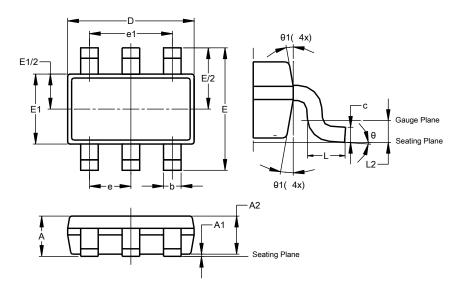
Fig. 13 Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26

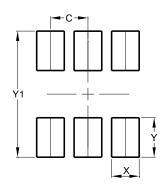


	TSOT26							
Dim	Min	Max	Тур					
Α	1	1.00	_					
A1	0.010	0.100	_					
A2	0.840	0.900	_					
D	2.800	3.000	2.900					
Е	2.800 BSC							
E1	1.500	1.700	1.600					
b	0.300	0.450	-					
С	0.120	0.200	_					
е	0.950 BSC							
e1	1.900 BSC							
L	0.30	0.50 –						
L2	0.250 BSC							
θ	0°	8°	4°					
θ1	4°	12°	-					
Α	All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Υ	1.000
Y1	3.199



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